

330mΩ, 650V, Super Junction N-Channel Power MOSFET
SRC65R330EC

General Description

The Sanrise SRC65R330EC is a high voltage power MOSFET, fabricated using advanced super junction technology. The resulting device has extremely low on resistance, low gate charge and fast switching time, making it especially suitable for applications which require superior power density and outstanding efficiency.

The SRC65R330EC break down voltage is 650V and it has a high rugged avalanche characteristics. The SRC65R330EC is available in TO-252 ,TO-220F, TO-262, TO-263-2,TO-220F Narrow and TO-220C packages .

Features

- Ultra Low $R_{DS(ON)}$ = 330mΩ @ V_{GS} = 10V.
- $V_{DS} @ T_{Jmax} = 700V$
- Ultra Low Gate Charge, $Q_g = 27.2nC$ typ.
- Fast switching capability
- Robust design with better EAS performance
- EMI Improved Design (**SnowMOS™ Gen.2**)
- Non-automotive Qualified

Application

- TV Power
- High Performance Charger / Adapter

Ordering Information



Package	Part Number	Marking ID	Packing Type
TO-252	SRC65R330ECDTR-G	SRC65R330ECDG	Tape & Reel
TO-263-2	SRC65R330ECS2TR-G	SRC65R330ECS2G	Tape & Reel
TO-220F	SRC65R330ECTF-G	SRC65R330ECTFG	Tube
TO-262	SRC65R330ECTS-G	SRC65R330ECTSG	Tube
TO-220C	SRC65R330ECTC-G	SRC65R330ECTCG	Tube
TO-251	SRC65R330ECD1-G	SRC65R330ECD1G	Tape & Reel
TO-220F Narrow	SRC65R330ECTFN-G	SRC65R330ECTFNG	Tube

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Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Drain-Source Voltage (Note2)	V _{DSS}	650	V
Gate-Source Voltage (static)	V _{GSS}	±20	V
Gate-Source Voltage (dynamic), AC (f>1 Hz)	V _{GSS}	±30	V
Continuous Drain Current	T _C =25°C	12.5 (Note3)	A
	T _C =100°C		
	T _C =125°C		
Pulsed Drain Current (Note 4)	I _{DM}	37.5	A
Avalanche Energy, Single Pulse (Note 5)	E _{AS}	109	mJ
Avalanche Energy, Repetitive (Note 4)	E _{AR}	0.1	mJ
Avalanche Current, Repetitive (Note 4)	I _{AR}	1.8	A
Continuous Diode Forward Current	I _S	12.5	A
Diode Pulse Current	I _{S,PULSE}	37.5	A
Power Dissipation (T _c =25°C, TO-220F, TO-220F Narrow)	P _{tot}	30	W
Power Dissipation (T _c =25 °C, TO-252, TO-263-2, TO-262, TO-220C, TO-251)	P _{tot}	75	W
Operating Junction Temperature	T _J	150	°C
Storage Temperature	T _{STG}	-55 to 150	°C
Lead Temperature (Soldering, 10 sec)	T _{LEAD}	260	°C

Note:

1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.
Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. For voltage spike during switching.
3. Duty=70%
4. Repetitive Rating: Pulse width limited by maximum junction temperature
5. I_{AS}= 1.8A, V_{DD} = 60V, R_G = 25Ω, Starting T_J = 25°C

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Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal resistance, Junction-to-Case	R_{thJC}	TO-220F		4.05	°C /W
		TO-220F Narrow		4.05	
		TO-252		1.65	
		TO-262		1.65	
		TO-263-2		1.65	
		TO-220C		1.65	
		TO-251		1.65	
Thermal resistance, Junction-to-Ambient	R_{thJA}	TO-220F		70	°C /W
		TO-220F Narrow		70	
		TO-252		62	
		TO-262		62	
		TO-263-2		62	
		TO-220C		62	
		TO-251		62	

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Electrical Characteristics

T_J = 25 °C, unless otherwise specified.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	650			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V			1	uA
Gate-Body Leakage Current	Forward	I _{GSSF}	V _{GS} =30V, V _{DS} =0V		100	nA
	Reverse	I _{GSSR}	V _{GS} =-30V, V _{DS} =0V		-100	
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	2.7	3.5	4.3	V
Static Drain-Source On-Resistance	R _{Ds(ON)}	V _{GS} =10V, I _D =5.5A		290	330	mΩ
Gate Resistance	R _G	f=1MHz, Open Drain		6.5		Ω
Dynamic Characteristics						
Input Capacitance	C _{ISS}	V _{DS} =50V, V _{GS} =0V, f=1MHz		470		pF
Output Capacitance	C _{OSS}			48		
Reverse Transfer Capacitance	C _{RSS}			28		
Effective output capacitance, energy related <small>NOTE5</small>	C _{O(er)}	V _{GS} =0V, V _{DS} =0...480V		24		pF
Effective output capacitance, time related <small>NOTE6</small>	C _{O(tr)}			110		
Turn-on Delay Time	t _{d(on)}	V _{DD} =400V, I _D =5.5A R _G =10Ω, V _{GS} =10V		11		ns
Rise Time	t _r			12		
Turn-off Delay Time	t _{d(off)}			41		
Fall Time	t _f			15		
Gate Charge Characteristics						
Gate to Source Charge	Q _{gs}	V _{DD} =480V, I _D =5.5A V _{GS} =0 to 10V		6.0		nC
Gate to Drain Charge	Q _{gd}			13.4		
Gate Charge Total	Q _g			27.2		
Gate Plateau Voltage	V _{plateau}			5.7		
Reverse Diode Characteristics						
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _{SD} =5.5A		0.83	1.1	V
Reverse Recovery Time	t _{rr}	V _R =400V, I _F =5.5A dI _F /dt=100A/us		214		ns
Reverse Recovery Charge	Q _{rr}			1.73		uC
Peak Reverse Recovery Current	I _{rrm}			16.2		A

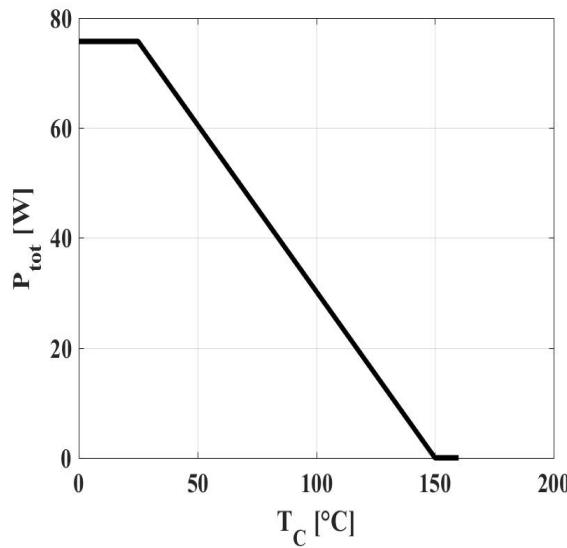
Note:

5. C_{O(er)} is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 to 480V

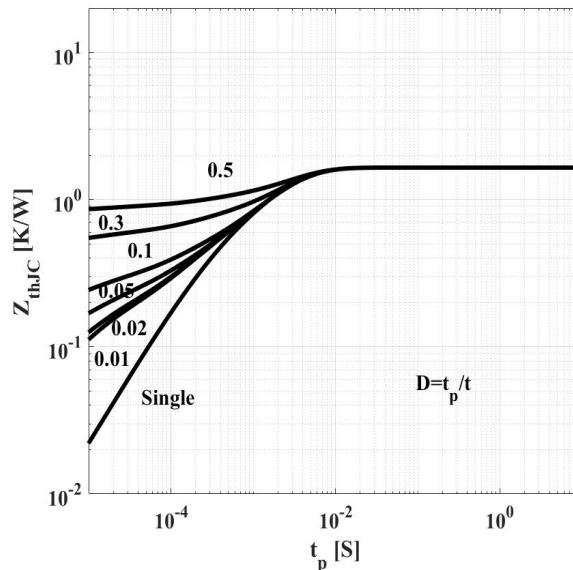
6. C_{O(tr)} is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 480 V

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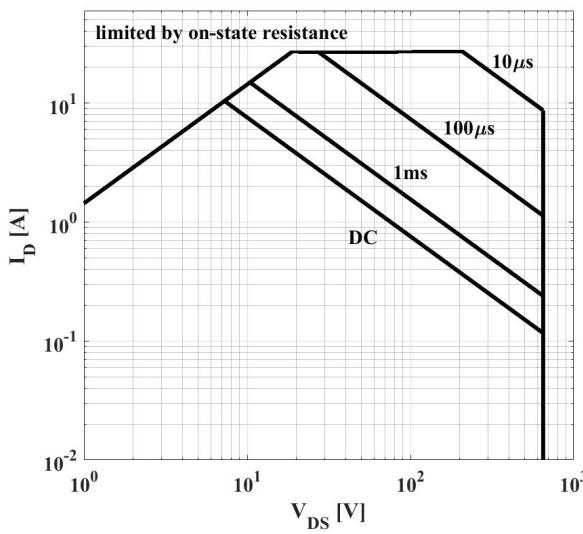
Typical Performance Characteristics

Figure 3: Power Dissipation


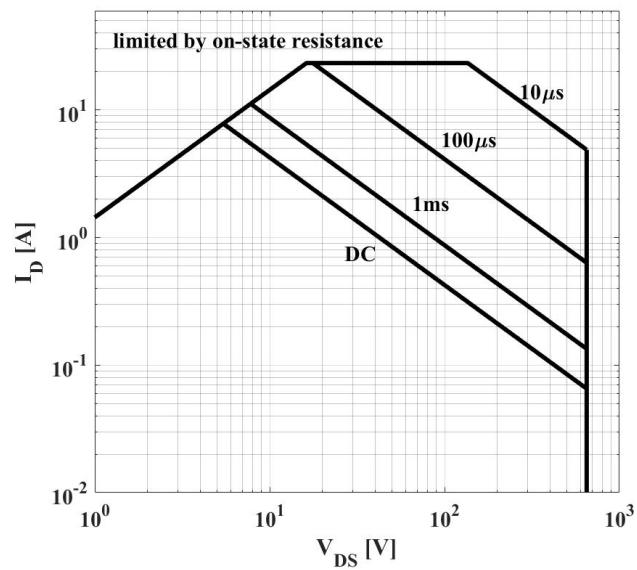
$$P_{tot} = f(T_c)$$

Figure 4: Max. Transient Thermal Impedance


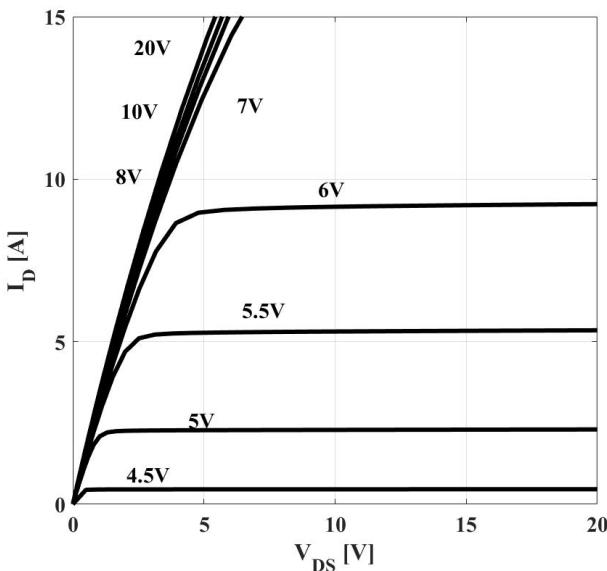
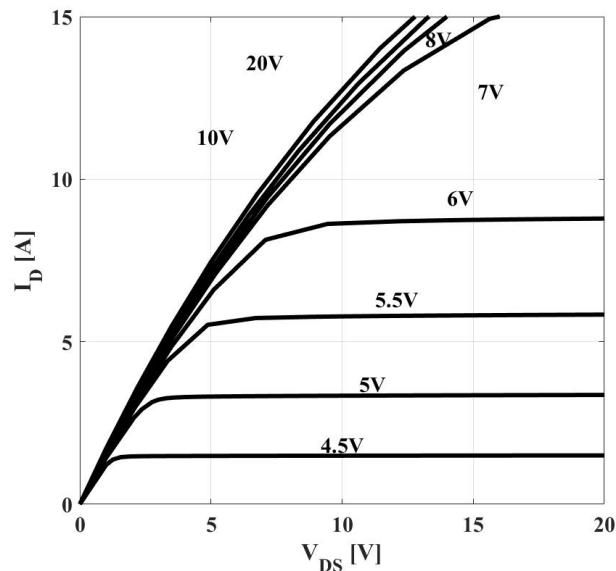
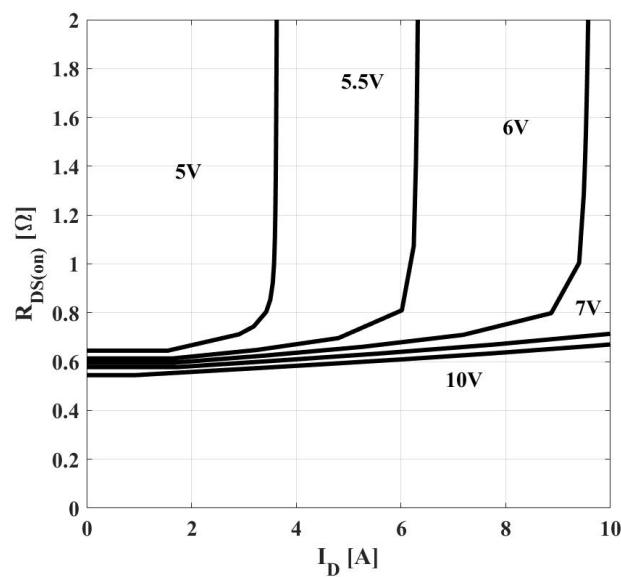
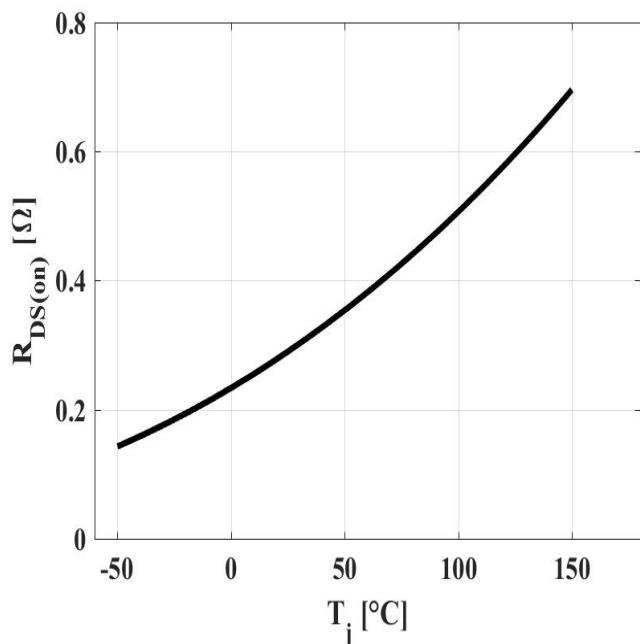
$$Z_{thJC} = f(t_p); \text{ parameter: } D = t_p/T$$

Figure 5: Safe Operating Area


$$I_D = f(V_{DS}); T_c = 25^\circ\text{C}; V_{GS} > 7\text{V}; \text{parameter } t_p$$

Figure 6: Safe Operating Area


$$I_D = f(V_{DS}); T_c = 80^\circ\text{C}; V_{GS} > 7\text{V}; \text{parameter } t_p$$

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Figure 7: Typ. Output Characteristics

 $I_D = f(V_{DS})$; $T_j = 25^\circ\text{C}$; parameter: V_{GS}
Figure 8: Typ. Output Characteristics

 $I_D = f(V_{DS})$; $T_j = 125^\circ\text{C}$; parameter: V_{GS}
Figure 9: Typ. Drain-Source On-State Resistance

 $R_{DS(\text{on})} = f(I_D)$; $T_j = 125^\circ\text{C}$; parameter: V_{GS}
Figure 10: Typ. Drain-Source On-State Resistance

 $R_{DS(\text{on})} = f(T_j)$; $I_D = 5.5\text{A}$; $V_{GS} = 10\text{V}$

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Figure 11: Typ. Transfer Characteristics

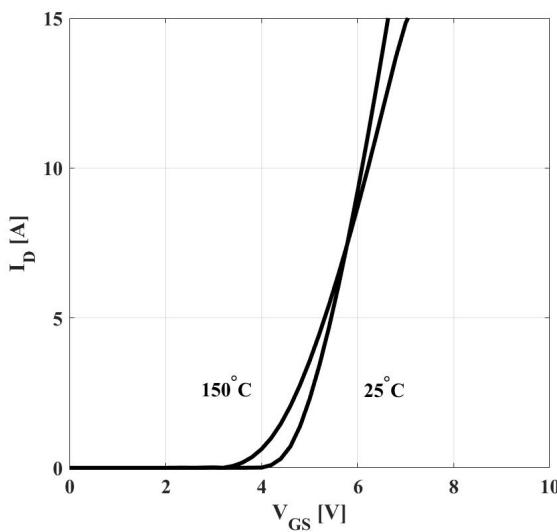


Figure 12: Typ. Gate Charge

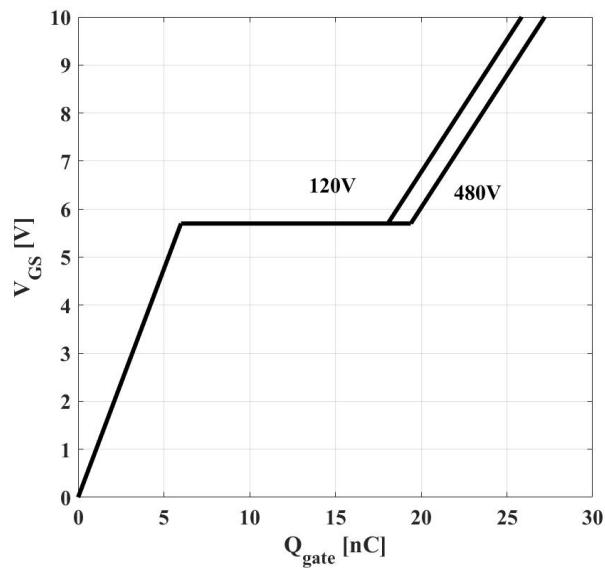

 $I_D = f(V_{GS})$; $V_{DS} = 20V$
 $V_{GS} = f(Q_{gate})$, $I_D = 5.5A$ pulsed

Figure 13: Drain-Source Breakdown Voltage

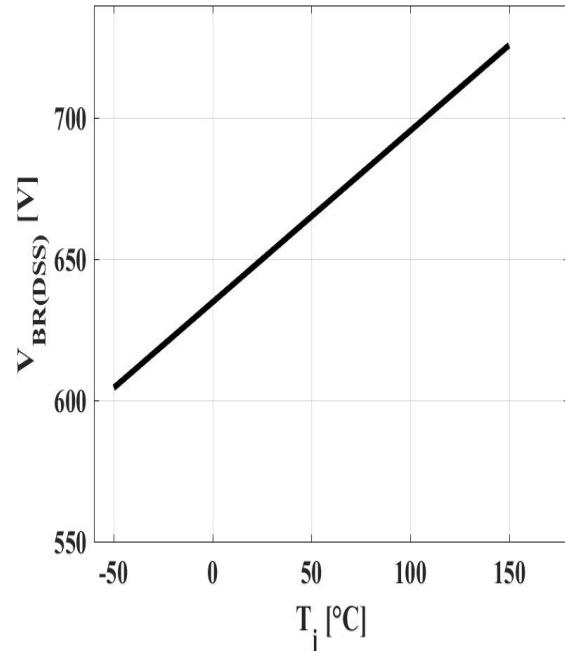
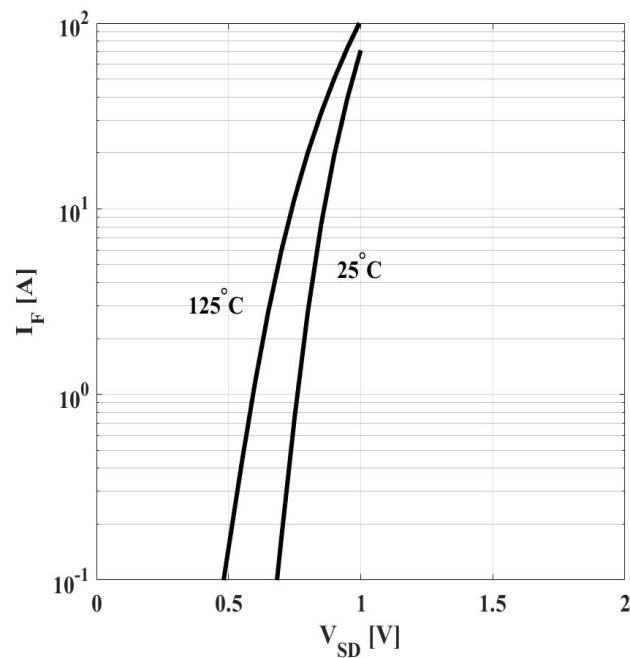
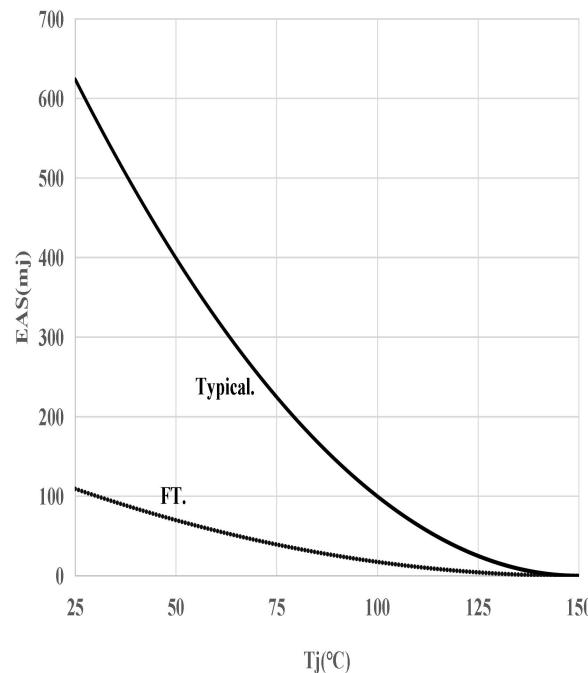
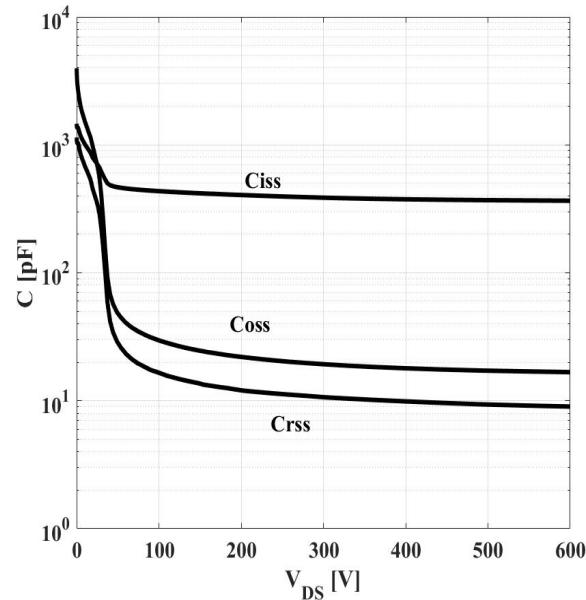

 Minimum $V_{BR(DSS)} = f(T_j)$; $I_D = 10mA$

Figure 14: Forward Characteristics of Reverse Diode

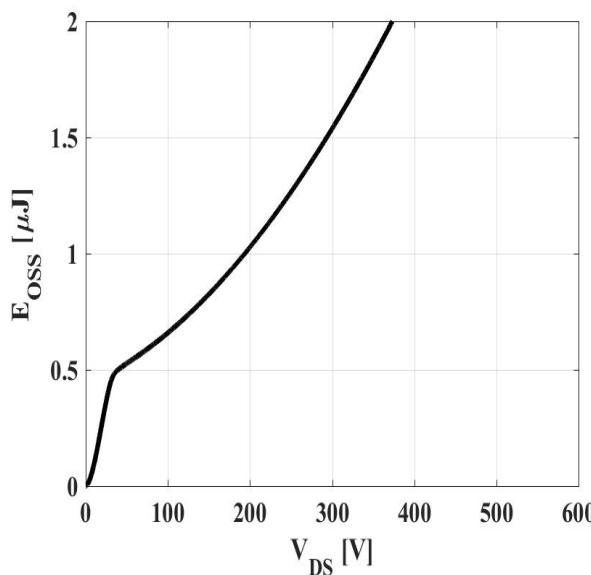

 $I_F = f(V_{SD})$; parameter: T_j

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Figure 15: Avalanche Energy


$$E_{AS}=f(T_j); I_D=1.8A; V_{DD}=60V$$

Figure 16: Typ. Capacitances


$$C=f(V_{DS}); V_{GS}=0; f=1MHz$$

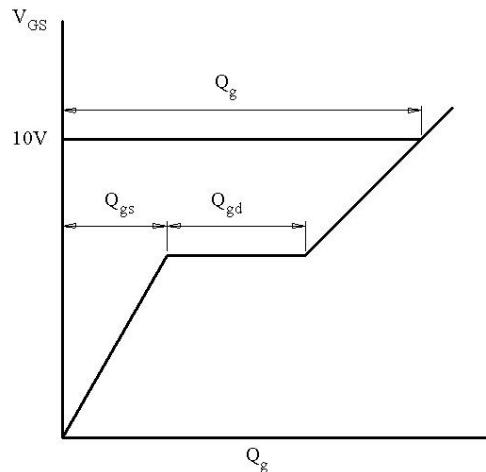
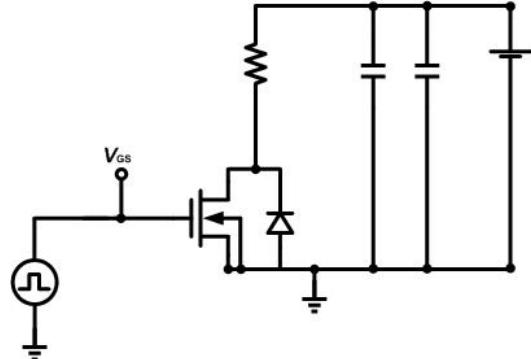
Figure 17: Coss Stored Energy


$$E_{oss}=f(V_{DS})$$

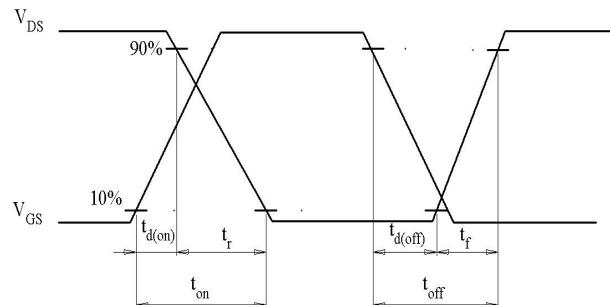
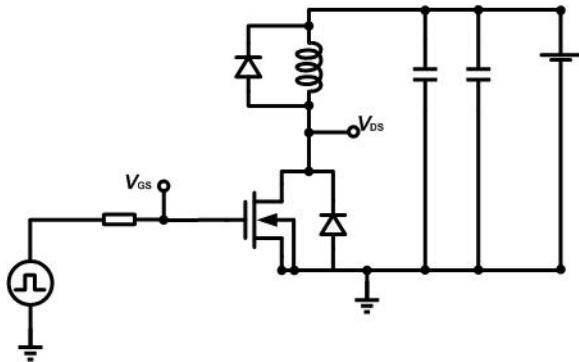
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Test Circuits

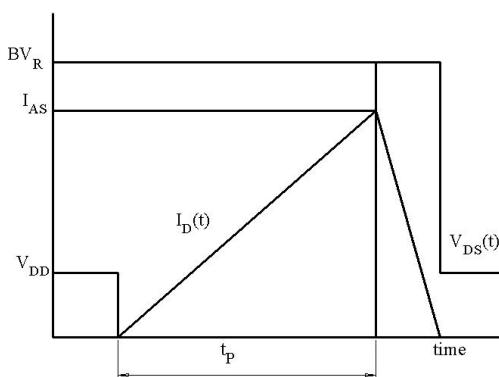
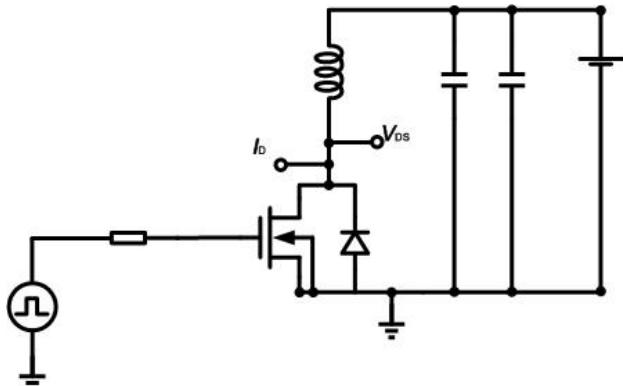
1. Gate Charge Test Circuit & Waveform



2. Switch Time Test Circuit

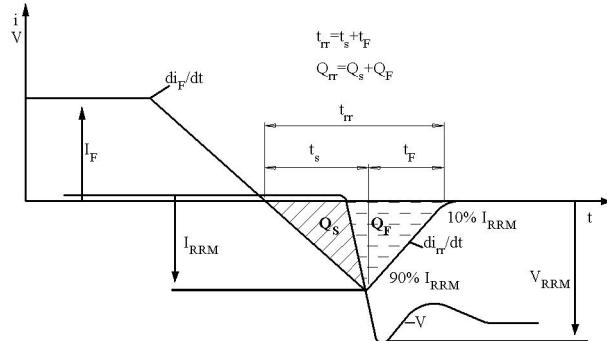
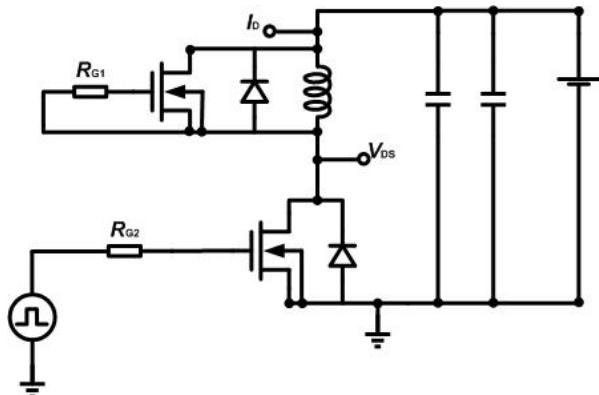


3. Unclaimed Inductive Switching Test Circuit & Waveforms



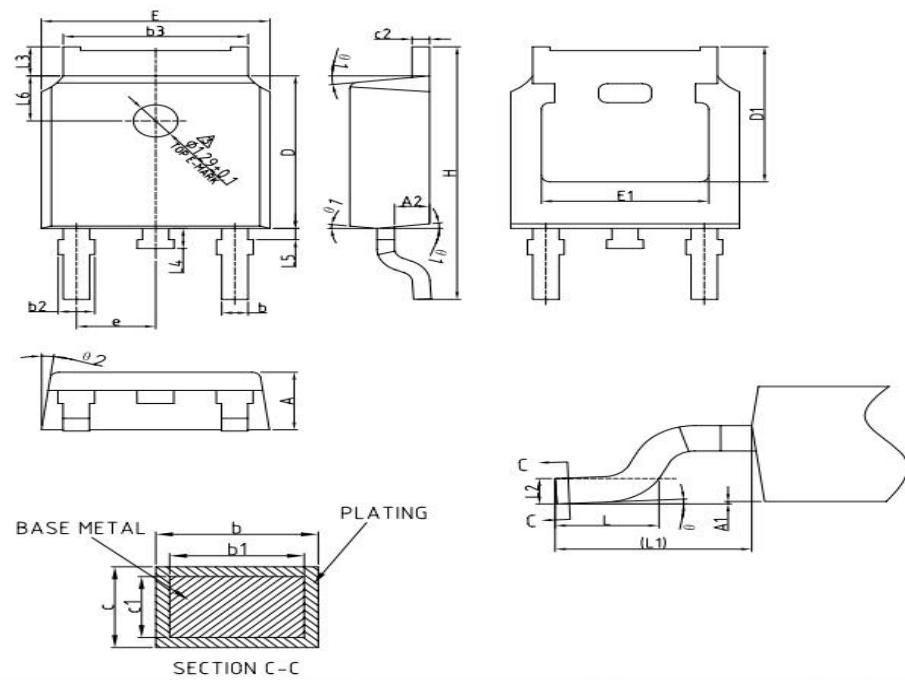
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4. Test Circuit and Waveform for Diode Characteristics



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Mechanical Dimensions

TO-252 (Package 1)
Unit: mm


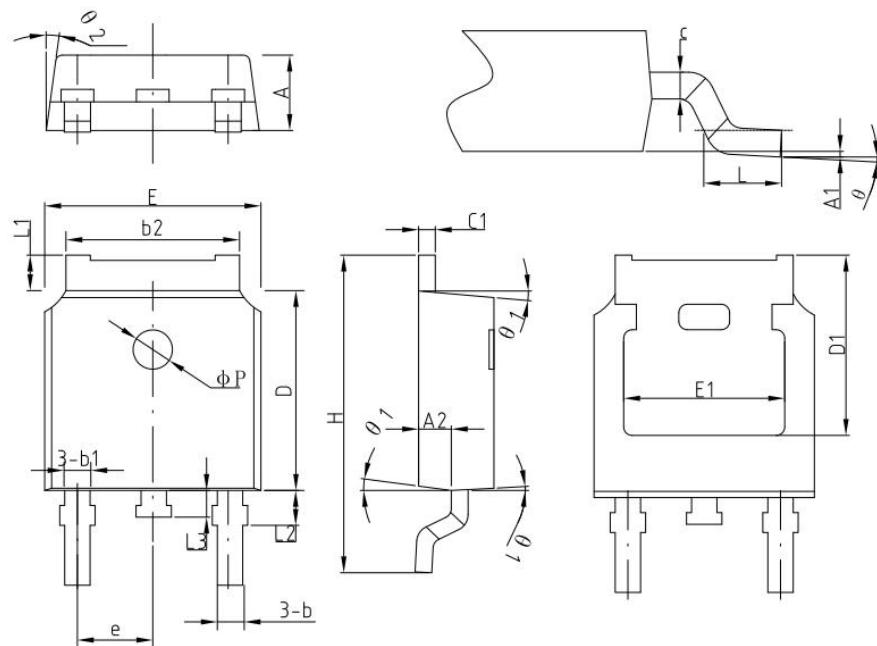
Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	2.20	2.30	2.38
A1	0	-	0.10
A2	0.90	1.01	1.10
b	0.72	-	0.85
b1	0.71	0.76	0.81
b2	0.72	-	0.90
b3	5.13	5.33	5.46
c	0.47	-	0.60
c1	0.46	0.51	0.56
C2	0.47	-	0.60
D	6.0	6.10	6.20
D1	5.25	-	-
E	6.50	6.60	6.70
E1	4.70	-	-
e	2.186	2.286	2.386
H	9.80	10.10	10.40
L	1.40	1.50	1.70
L1	2.90REF		
L2	0.51BSC		
L3	0.90	-	1.25
L4	0.60	0.80	1.00
L5	0.15	-	0.75
L6	1.80REF		
θ	0°	-	8°
Θ1	5°	7°	9°
Θ2	5°	7°	9°



Mechanical Dimensions

TO-252 (Package 2)

Unit: mm



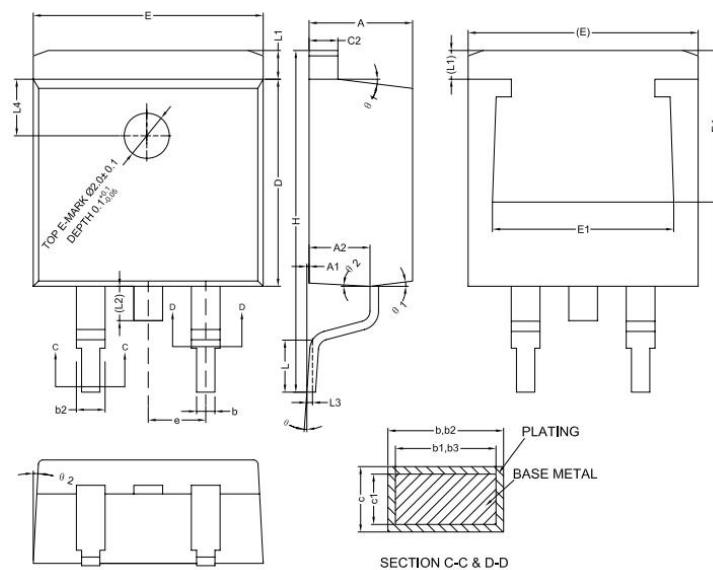
Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	2.20	2.30	2.38
A1	0	-	0.127
A2	0.90	1.01	1.10
b	0.635	0.76	0.86
b1	-	0.76	-
b2	5.2	5.33	5.46
c	0.47	0.50	0.60
c1	0.47	0.50	0.60
D	6.0	6.10	6.20
D1	-	5.30	-
E	6.50	6.60	6.70
E1	-	4.83	-
e	2.286(BSC)		
H	9.70	10.10	10.40
L	1.40	1.50	1.70
L1	0.90	-	1.25
L2	-	1.0	-
L3	-	0.8	-
φ P	-	1.2	-
θ	0°	-	8°
θ1	5°	7°	9°
θ2	5°	7°	9°



Mechanical Dimensions

TO-263-2 (Package 1)

Unit: mm



Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.40	4.57	4.70
A1	0.00	0.10	0.25
A2	2.59	2.69	2.79
b	0.77	-	0.90
b1	0.76	0.81	0.86
b2	1.23	-	1.36
b3	1.22	1.27	1.32
c	0.34	-	0.47
c1	0.33	0.38	0.43
c2	1.22	-	1.32
D	9.05	9.15	9.25
D1	6.60	-	-
E	10.06	10.16	10.26
E1	7.80	-	8.20
e	2.54(BSC)		
H	14.70	15.10	15.50
L	2.00	2.30	2.60
L1	1.17	1.27	1.40
L2	-	-	1.75
L3	0.25BSC		
L4	2.00REF		
θ	0°	-	8°
θ1	5°	7°	9°
θ2	1°	3°	5°



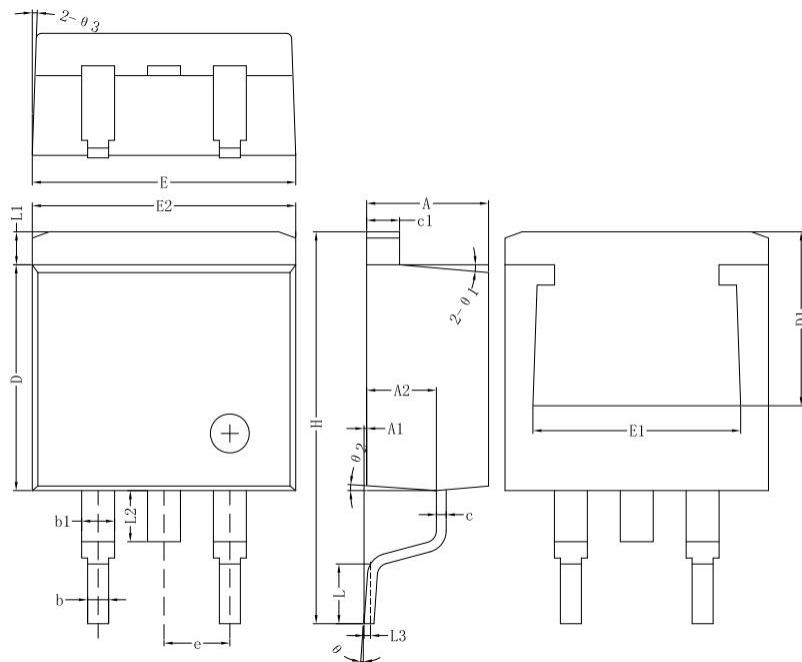
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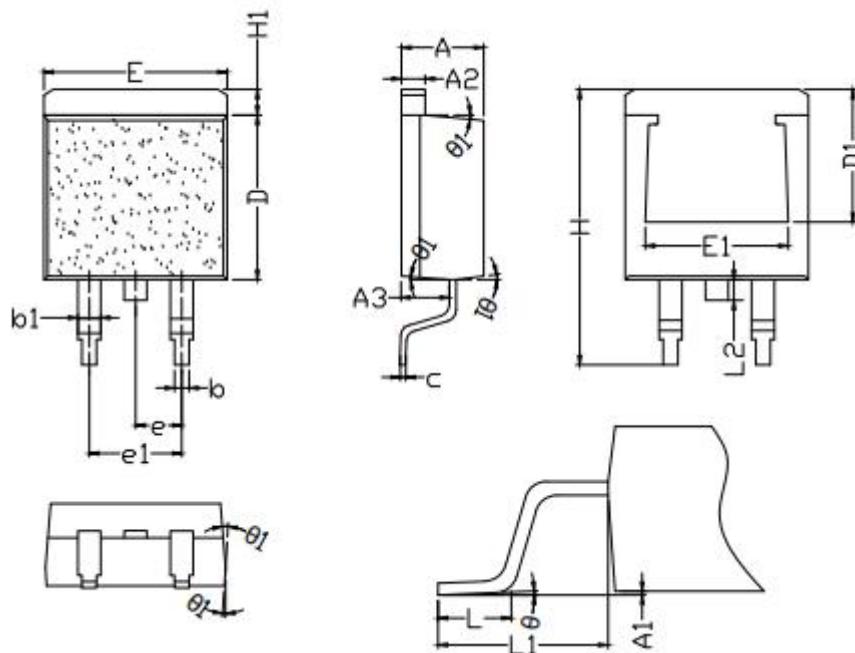
Mechanical Dimensions

TO-263-2 (Package 2)

Unit: mm



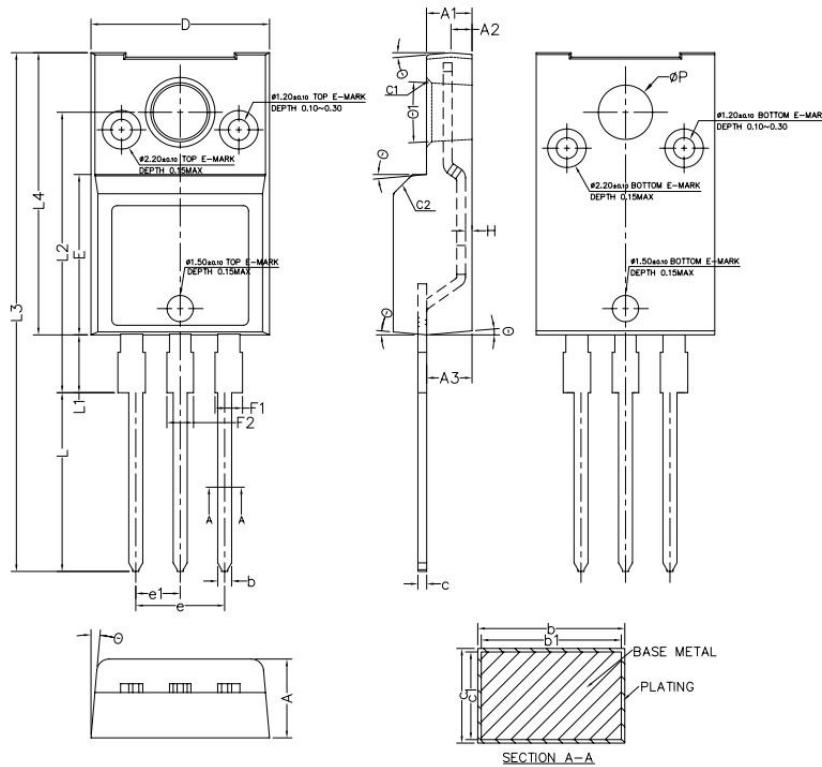
Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.55	4.70	4.85
A1	0.00	0.10	0.25
A2	2.59	2.69	2.89
b	0.71	0.81	0.96
b1	-	1.27	-
c	0.36	0.38	0.61
c1	1.17	1.27	1.37
D	8.55	8.70	8.85
D1	-	7.2	-
E	10.01	10.16	10.31
E1	-	7.80	-
E2	9.98	10.08	10.18
e	-	2.54	-
H	14.70	15.10	15.50
L	2.00	2.30	2.70
L1	1.17	1.27	1.40
L2	-	-	2.20
L3	-	0.25BSC	-
θ	0°	-	8°
θ1		5°	
θ2		4°	
θ3		4°	

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Mechanical Dimensions
TO-263-2 (Package 3)
Unit: mm


Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.42	4.52	4.62
A1	0.00	0.10	0.25
A2	1.24	1.27	1.32
A3	2.50	2.60	2.70
b	0.77	0.81	0.84
b1	1.23	1.28	1.41
c	0.33	0.38	0.43
D	8.80	8.95	9.10
D1	7.2REF		
E	9.92	10.07	10.22
E1	7.85REF		
e	2.50	2.54	2.58
e1	5.08REF		
H	14.80	15.10	15.30
H1	1.12	1.28	1.42
L	2.10	2.23	2.36
L1	4.55	4.75	4.95
L2	1.10	1.30	1.50
θ	0°	2°	5°
θ1	3°	-	5°

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Mechanical Dimensions

TO-220F (Package 1)
Unit: mm


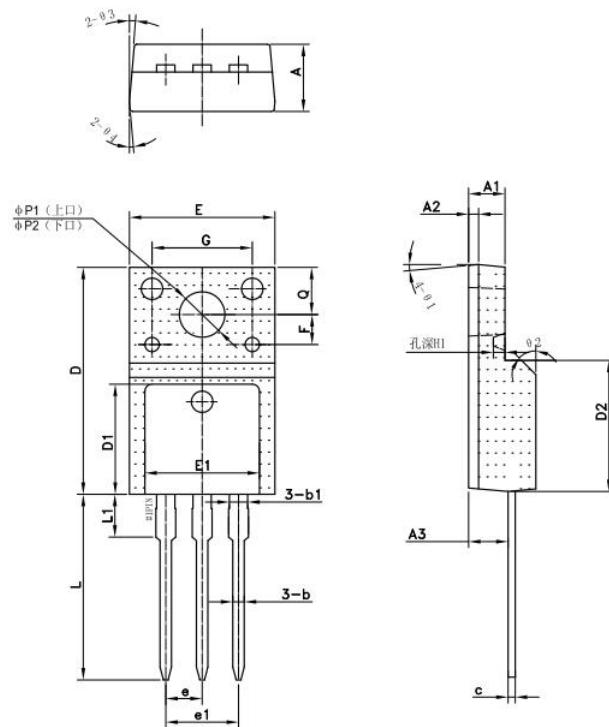
Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.40	4.50	4.60
A1	2.50	2.60	2.70
A2	1.10	1.20	1.30
A3	2.49	2.59	2.69
b	0.76	-	0.89
b1	0.75	0.80	0.85
c	0.46	-	0.59
c1	0.45	0.50	0.55
C1	0.20	0.30	0.40
C2	1.00	1.10	1.20
D	10.10	10.20	10.30
E	9.05	9.15	9.25
e	4.98	5.08	5.18
e1	2.44	2.54	2.64
F1	1.22	-	1.60
F2	1.17	-	1.55
H	0.32	0.37	0.42
L	10.00	10.20	10.40
L1	3.15	3.30	3.45
L2	15.85	16.00	16.15
L3	29.30	29.60	29.90
L4	16.00	16.10	16.20
P	3.00	3.10	3.20
θ	3°	5°	7°
θ1	4°	6°	8°



Mechanical Dimensions

TO-220F (Package 2)

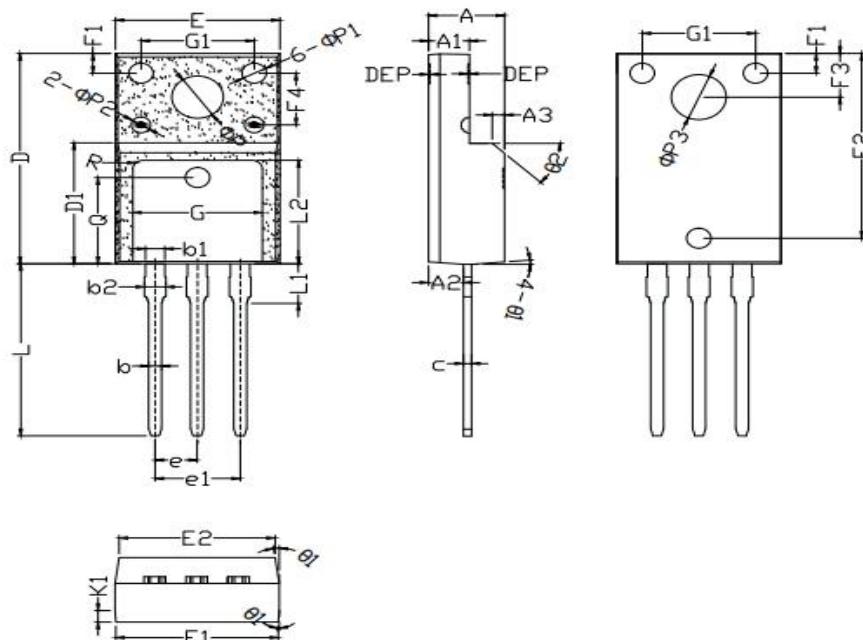
Unit: mm



Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.50	4.70	4.90
A1	2.34	2.54	2.70
A2	-	0.70	-
A3	2.56	2.76	2.96
b	0.70	0.80	0.95
b1	-	1.28	-
c	0.45	0.50	0.65
D	15.67	15.87	16.07
D1	-	7.70	-
D2		9.12	
E	9.96	10.16	10.36
E1	-	8.00	-
e		2.54	
e1		5.08	
F		2.1	
G		7	
H1	-	0.81	-
L	12.48	12.98	13.20
L1	-	2.93	-
ΦP1 (上口)	2.98	3.18	3.38
ΦP2 (下口)	3.20	3.40	3.60
Q	3.10	3.30	3.50
θ1		5°	
θ2		45°	
θ2		5°	
θ3		5°	

330mΩ, 650V, Super Junction N-Channel Power MOSFET
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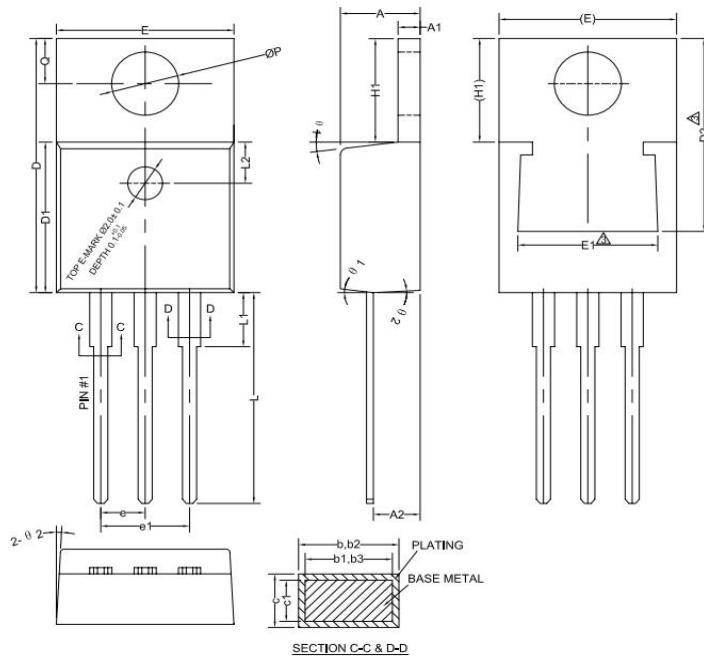
Mechanical Dimensions

TO-220F (Package 3)
Unit: mm


Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A2	2.60	2.80	2.95
A3		1.0REF	
b	0.75	0.80	0.85
b1	1.18	1.20	1.24
b2	1.18	1.24	1.30
c	0.45	0.50	0.55
D	15.67	15.87	16.07
D1	9.04	9.12	9.20
E	10.00	10.16	10.30
E1	9.94	10.06	10.30
E2	9.40	9.50	9.60
e	2.50	2.54	2.58
e1		5.08REF	
L	12.78	12.98	13.18
L1	2.70	2.92	3.20
L2	7.70	7.80	7.90
Q		6.50REF	
ΦP	3.08	3.18	3.28
ΦP1	1.45	1.55	1.65
ΦP2	0.95	1.15	1.35
ΦP3	3.30	3.40	3.50
θ1	3°	5°	7°
θ2	42°	45°	48°
F1	1.40	1.50	1.60
F2	13.80	13.90	14.00
F3	3.20	3.30	3.40
F4	3.70	3.90	4.10
G	7.80	8.00	8.20
G1	6.90	7.00	7.10
K1	0.65	0.70	0.75

330mΩ, 650V, Super Junction N-Channel Power MOSFET
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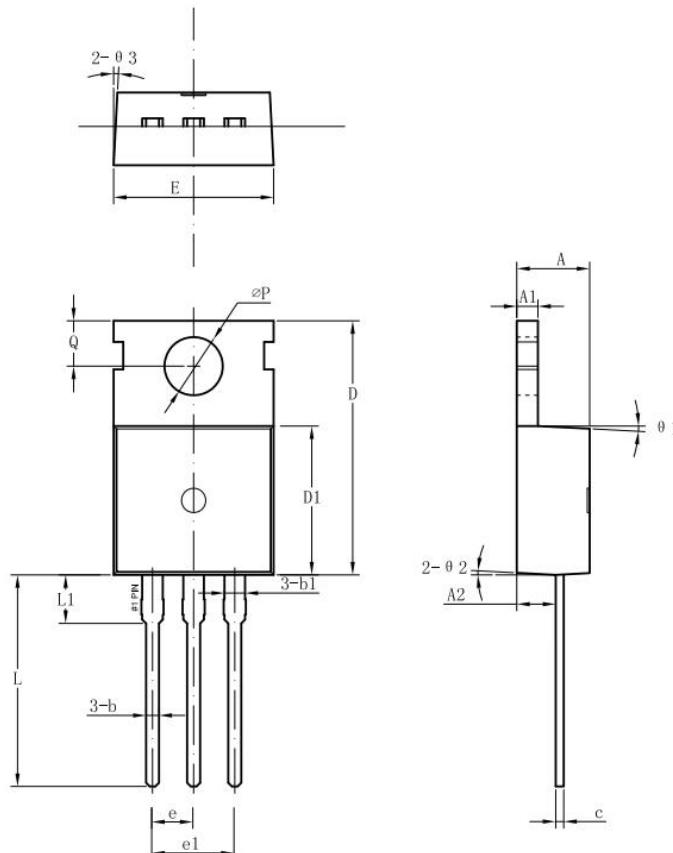
Mechanical Dimensions

TO-220C (Package 1)
Unit: mm


Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.40	4.57	4.70
A1	1.22	-	1.32
A2	2.59	2.69	2.79
b	0.77	-	0.90
b1	0.76	0.81	0.86
b2	1.23	-	1.36
b3	1.22	1.27	1.32
c	0.34	-	0.47
c1	0.33	0.38	0.43
D	15.15	15.45	15.75
D1	9.05	9.15	9.25
D2	11.40	-	12.88
E	9.96	10.16	10.36
E1	6.86	-	8.89
e	2.44	2.54	2.64
e1	4.98	5.08	5.18
H1	6.10	6.30	6.50
L	12.70	-	13.12
L1	-	-	3.90
ΦP	3.80	3.84	3.88
Q	2.60	-	2.90
θ1	5°	7°	9°
θ2	1°	2°	5°

330mΩ, 650V, Super Junction N-Channel Power MOSFET
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Mechanical Dimensions

TO-220C (Package 2)
Unit: mm


Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.30	4.50	4.70
A1	1.25	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b1	-	1.27	-
c	0.40	0.50	0.65
D	15.20	15.70	16.20
D1	9.00	9.20	9.40
E	9.70	10.00	10.20
e		2.54	
e1		5.08	
L	12.60	13.08	13.60
L1	-	3.00	-
ΦP	3.50	3.60	3.80
Q	2.60	2.80	3.00
θ1		3°	
θ2		3°	
θ2		3°	



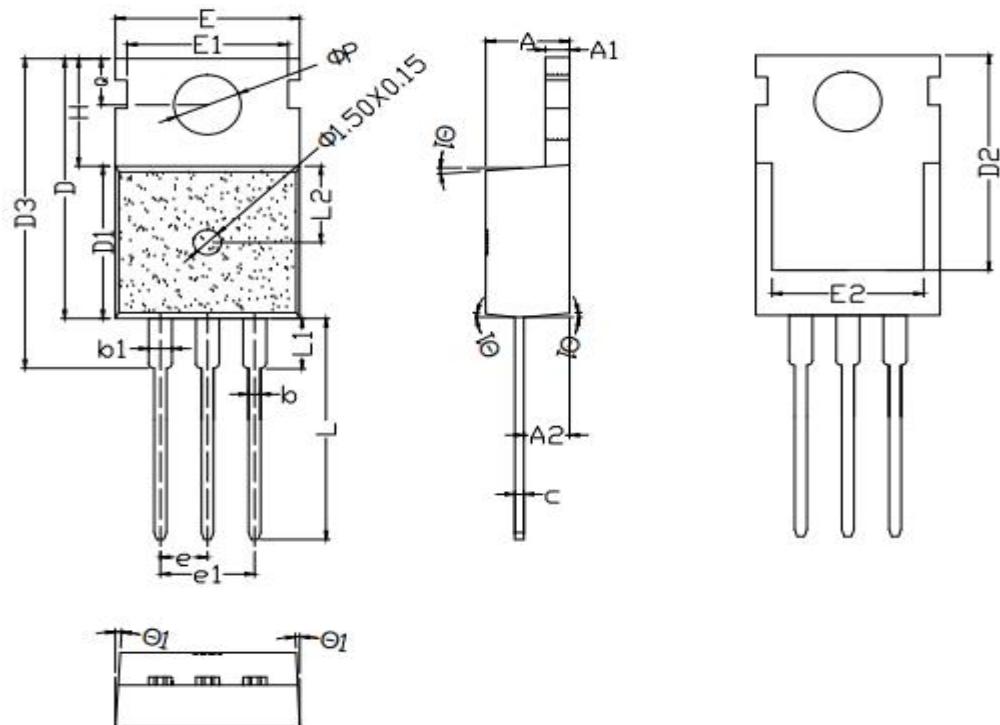
330mΩ, 650V, Super Junction N-Channel Power MOSFET

SRC65R330EC

Mechanical Dimensions

TO-220C (Package 3)

Unit: mm



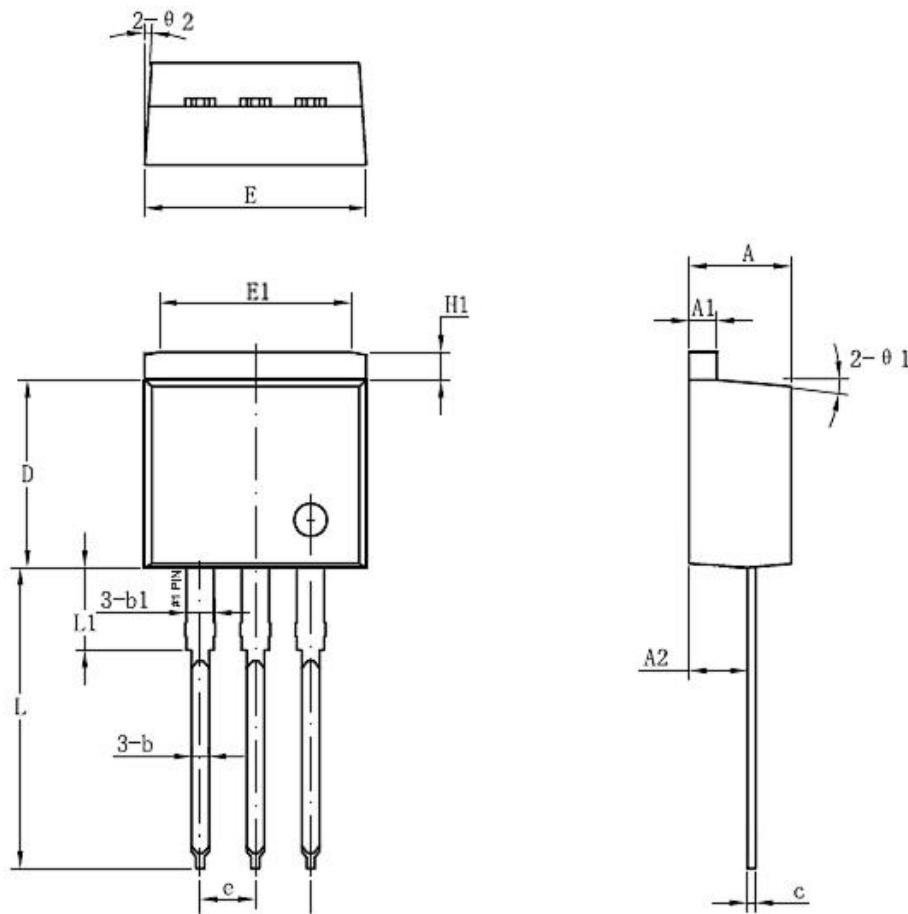
Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.40	4.50	4.60
A1	1.25	1.30	1.35
A2	2.30	2.40	2.50
b	0.70	0.80	0.90
b1	1.25	1.33	1.42
c	0.45	0.50	0.55
D	15.50	15.75	16.00
D1	9.10	9.20	9.30
D2	12.90	13.10	13.30
D3	15.45	15.80	16.15
E	9.80	10.02	10.15
e	2.54BSC		
e1	5.08BSC		
L	13.00	13.28	13.45
L1	-	-	3.40
ΦP	3.55	3.65	3.75
Q	2.65	2.75	2.85
θ1	2°	-	7°
E1	8.55	8.70	8.85
E2	7.40	7.60	7.80
H	6.40	6.50	6.60
L2	4.50	4.65	4.80



Mechanical Dimensions

TO-262

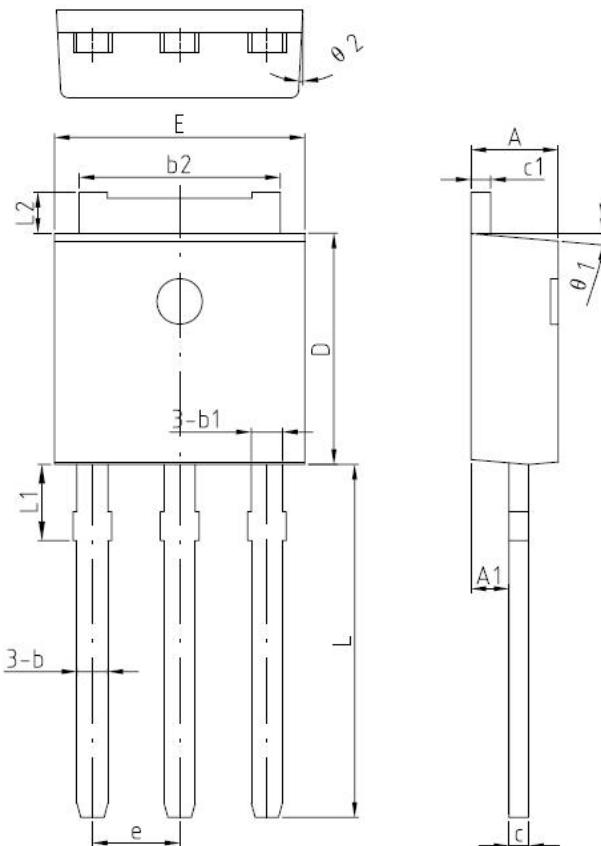
Unit: mm



Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.30	4.65	4.85
A1	1.17	1.27	1.40
A2	2.20	-	2.89
b	0.70	0.81	0.96
b1	-	1.27	-
c	0.36	0.40	0.61
D	8.55	-	9.4
E	9.80	10.10	10.31
E1	-	8.80	-
e	2.54(BSC)		
H1	1.00	1.25	1.40
L	12.60	-	14.08
L1	-	3.8	-
θ1		5°	
θ2		4°	

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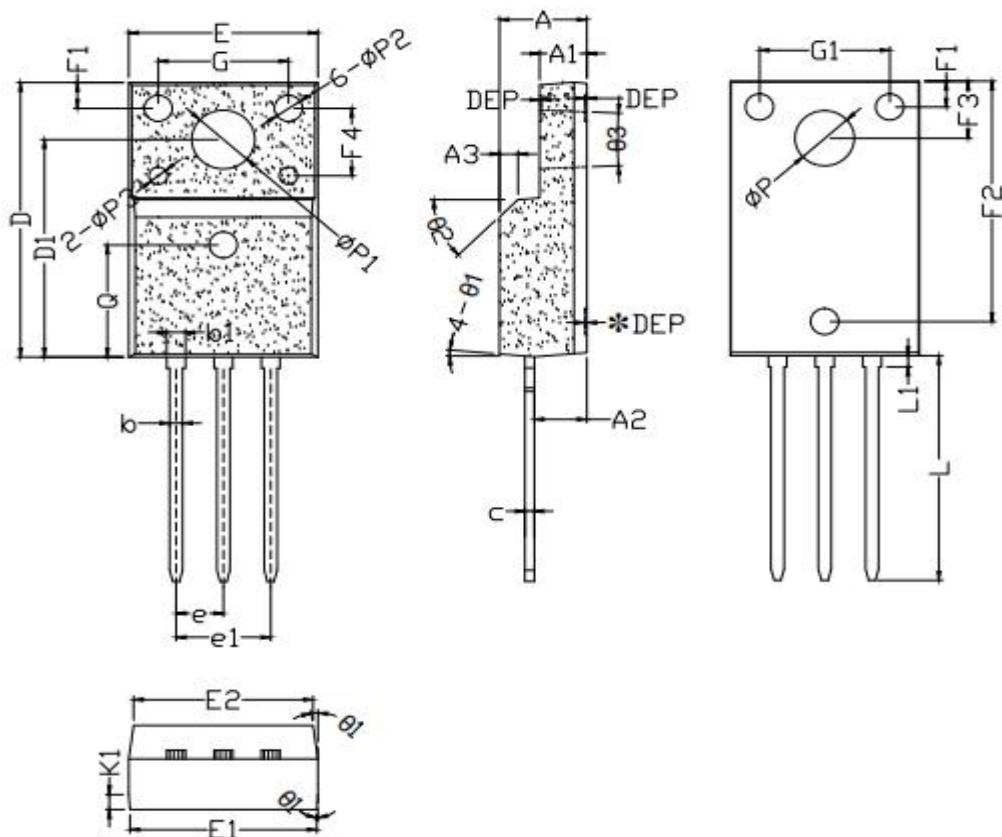
Mechanical Dimensions

TO-251
Unit: mm


Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	2.20	2.30	2.40
A1	0.90	1.01	1.17
b	0.50	-	0.91
b1	-	0.81	-
b2	5.13	5.33	5.46
c	0.46	0.50	0.60
c1	0.46	0.50	0.60
D	5.95	6.10	6.25
E	6.45	6.60	6.75
e	2.286(BSC)		
L	9.00	9.30	9.60
L1	-	2.00	-
L2	0.90	-	1.25
θ1	-	5°	-
θ2	-	3°	-

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Mechanical Dimensions

TO-220F Narrow
Unit: mm


Symbol	Dimensions(mm)			Symbol	Dimensions(mm)		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.60	4.70	4.80	E1	9.94	10.06	10.20
A1	2.34	2.54	2.74	E2	9.30	9.40	9.50
A2	2.56	2.76	2.93	F1	1.40	1.50	1.60
A3	1.0REF			F2	13.80	13.90	14.00
b	0.60	0.70	0.80	F3	3.20	3.30	3.40
b1	0.90	1.00	1.10	F4	3.70	3.90	4.10
c	0.45	0.50	0.55	G1	6.90	7.00	7.10
D	15.67	15.87	16.07	K1	0.65	0.70	0.75
D1	12.37	12.57	12.77	L	12.78	12.98	13.18
E	10.06	10.16	10.26	L1	-	-	0.85
e	2.50	2.54	2.58	Q	6.50REF		
e1	5.08REF			ΦP	3.08	3.18	3.28
ΦP1	3.30	3.40	3.50	ΦP3	0.90	1.00	1.10
ΦP2	1.40	1.50	1.60	θ1	3°	5°	7°
Θ2	42°	45°	48°	θ3	3°	5°	7°
DEF	0.05	0.10	0.15				



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Main Site:

- Headquarter

Shenzhen Sanrise Technology Co., LTD.

A1206, Skyworth building, No. 008, gaoxinnan 1st Road,
Gaoxin District, Yuehai street,, Nanshan District, ShenZhen,
P.R.China

Tel: +86-755-22953335

Fax: +86-755-22916878

- Shanghai Office

Shenzhen Sanrise Technology Co., LTD.

Rm.401, Building B, No. 666, Zhangheng Road,
Zhangjiang Hi-Tech Park, Shanghai, P.R.China

Tel: +86-21-68825918